

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0350230012 Part Weight 0.24G

Part Name 2MM R/A BOARD-IN CMP HSG /012/

Product Composition

Name	Туре	CAS Number Proportion (% Total)		Mass (Grams)	
2MM R/A BOARD-IN CMP HSG /012/	Component		100	0.24	
PA66-FR(30)	Material		100	0.24	
PA66	Substance		86.25	0.207	
Flame Retardant, ISO 1043-4 FR(30)	Substance		8	0.0192	
Further Additives, not to declare	Substance	system	1	0.0024	
Pigment portion, not to declare	Substance	system	0.75	0.0018	
Antimonytrioxide	Substance	1309-64-4	4	0.0096	

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Antimonytrioxide	PA66-FR(30)	*Note	50,000	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

None

Form Rev - F

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0350230012							
Part Name	2MM R/A BOARD-IN CMP HSG /012/	(e)						
Part Information				Наз	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE	
2MM R/A BO	ARD-IN CMP HSG /012/		0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	N/A
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021